SUMMARY OF THE INVENTION

It is a purpose of the invention to reduce integrated circuit (IC) sensitivity to floating body effects;

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It is another purpose of the invention to reduce body effect charge accumulation in ICs;

It is yet another purpose of the invention to reduce critical path sensitivity to floating body effects;

It is yet another purpose of the invention to reduce memory array sensitivity to floating body effects.

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The present invention relates to an integrated circuit (IC), random access memory on an IC and method of neutralizing device floating body effects. A floating body effect monitor monitors circuit/array activity and selectively provides an indication of floating body effect manifestation from inactivity, including the lapse of time since the most recent activity or memory access. A pulse generator generates a neutralization pulse in response to an indication of inactivity. A neutralization pulse distribution circuit passes the neutralization pulse to blocks in the circuit path or to array cells.

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BRIEF DESCRIPTION OF THE DRAWINGS

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The foregoing and other objects, aspects and advantages will be better understood from the following detailed description of a preferred embodiment of the invention with reference to the drawings, in which:

Figure 1 shows a cross section of a prior art SOI wafer through a single FET;

104-4, ..., 104-n, that may each be part of a test register for the particular logic path. A multiplexor (MUX) 106 provides a scan in to the first shift register stage 104-1. A test circuit 108, e.g., for built in self test (BIST), provides a test data input for the multiplexor 106. Thus, in this example, each shift register stage 104-1, 104-2, 104-3, 104-4, ..., 104n is shown with an input 104I and an output 104O to its corresponding logic block 102-1. 102-2, 102-3, 102-4, ..., 102-n. The other input to the multiplexor 106 is a body effect neutralization or discharge pulse generated by a body charge monitor circuit 110 and a Jischar Spulse generator 112.

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Body charge monitor 110 may be any suitable charge monitor circuit, such as described in U.S. Patent No. 6,078,058, entitled "SOI Floating Body Charge Monitor Circuit and Method" to Hsu et al., assigned to the assignee of the present invention and incorporated herein by reference. Pulse generator 112 may be any suitable state of the art pulse generator circuit. Logic blocks 102-1, 102-2, 102-3, 102-4, ..., 102-n, generically represent any suitable logic gate, circuit, macro, etc., providing an appropriate logic function for a particular application and, where n is determined by the sum of the nominal block delays and the clock period for the path. Shift register stages 104-1, 104-2, 104-3, 104-4, ..., 104-n, may be any suitable latch or register stage. In particular, shift register stages 104-1, 104-2, 104-3, 104-4, ..., 104-n, may be part of a test scan register string as shown and, each may be a typical level sensitive scan design (LSSD) latch with appropriate modification.

Further, as shown for the example of Figure 2B, logic blocks 102-1, 102-2, 102-3, 102-4, ..., 102-i, ..., 102-n, may be specifically modified to allow for floating body effect charge discharge or neutralization. So, in this example, a clocked CMOS logic gate 102-i is shown providing a clocked AND-OR-invert logic function. A complementary clock pair is provided with the true at the gates of NFETs 1020 and 1022 and the complement to the gate of PFET 1024. A first complementary logic signal pair is provided to the gates of NFETs 1026 and 1028. A second complementary logic signal pair is provided to

the gates of NFET 1030 and PFET 1032. A third logic signal is provided to the gate of NFET 1034. A set signal is provided at set input 1036 to the bodies of NFETs 1022, 1024, 1026, 1028, 1030 and 1034. For this example, whenever the body charge monitor 110 determines that gate 102-i has been dormant (i.e., the clock at the gates of NFETs 1026 and 1028 has remained low and the clock complement at the gate of PFET 1024 has remained high) for sufficient time that body charges have reached steady state and may affect gate 102-i performance; a set signal is provided at set input 1036 to discharge the bodies of NFETs 1022, 1024, 1026, 1028, 1030 and 1034 before the clock arrives. It should be noted that clocked CMOS logic gate 102-i is shown as a representative example of application of the present invention to any logic gate and not intended as a limitation. Body discharging as applied to clocked CMOS logic gate 102-i, may likewise be applied to any logic gate. It should further be noted that the set signal applied to set input 1036 is not necessarily a voltage associated with a logic one for the particular technology, but instead is a signal sufficient to discharge any body charge for connected FETs.

figure 2C is an example of a timing diagram of discharge or neutralization timing for the signal path 100 of Figure 2A. Each of shift register stages 104-1, 104-2, 104-3, 104-4, ..., 104-n, body charge monitor 110 and pulse generator 112 are clocked by a common clock 114. Whenever the data path is idled for a sufficient period of time for logic blocks 102-1, 102-2, 102-3, 102-4, ..., 102-n to have been affected by body effects, body charge monitor circuit 110 will provide an indication to that effect. In response, the pulse generator 112 will generate a neutralization pulse 116. The neutralization pulse 116 out of the pulse generator 112 passes through multiplexor 106 to the first register stage 104-1 and begins to propagate through the shift register stages 104-1, 104-2, 104-3, 104-4, ..., 104-n. With each succeeding clock cycle, the neutralization pulse passes to a corresponding one of the shift register stages 104-1, 104-2, 104-3, 104-4, ..., 104-n. As the pulse passes through each shift register stages 104-1, 104-2, 104-3, 104-4, ..., 104-n, it forces each corresponding logic block 102-1, 102-2, 102-3, 102-4, ..., 102-n into a

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neutralization mode. The neutralization pulse width may be several clock cycles long and is long enough to sufficiently discharge (i.e., neutralize) the path logic blocks 102-1, 102-2, 102-3, 102-4, ..., 102-n. Further, during each neutralization pulse and at each time the path is activated, the body charge monitor 110 is reset and, begins monitoring again at the end of the pulse or the activity. In neutralization mode each logic block 102-1, 102-2, 102-3, 102-4, ..., 102-n briefly switches device bias conditions on any devices that may be experiencing body effects, thereby, normalizing any such device to minimize body effects. Thus, subsequently, when a logic signal normally propagates through logic path 100, the path delay is closer to normal, rather than faster or slower than normal.

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Figure 3A shows an example of a random access memory (RAM) 130 with body effect compensation according to a preferred embodiment of the present invention. Figure 3B is a schematic of a single cell 132 in the RAM 130, a static RAM (SRAM) cell 132 in this example. Figure 3C is an example of a timing diagram of neutralization timing for the RAM 130. The RAM array 134 is organized in rows or word lines, e.g., 136, and columns 138 of bit line pairs, e.g., 140, 142. In this example, each column is 4 bits wide. Word decode logic 144 selects one of M word lines 136. Bit selection is provided by column select logic 146 to select pass gate pairs 148-0, 148-1, 148-2, 148-3 in one of the columns 138 in any access. Column select logic 146 also includes logic for selecting columns during a neutralization cycle, e.g., a counter for sequentially selecting each of N columns. As with the signal path 100 of Figure 2A, the RAM 130 includes a body charge monitor circuit 110' and a pulse generator 112 generating a body effect neutralization pulse. A body effect neutralization pulse is generated whenever the RAM 130 remains unaccessed long enough for body effects to have affected cells 132. In addition in this example, the body charge monitor circuit 110' provides a neutralization control signal 150 to a corresponding discharge pair 152-0, 152-1, 152-2, 152-3 for each bit.

As can be seen from Figure 3B, the SRAM cell 132 is essentially a pair of cross coupled inverters 160, 162, connected between a pair of word line pass gates 164, 166. A one may be stored as the cross coupled inverters 160, 162 set in one state (e.g., 160 providing a high) and a zero in the other (with 162 providing a high). The word line pass gates 164, 166 are connected between the cross coupled inverters 160, 162 and the bit line pair, e.g., 140, 142. The word line 136 turns on and off the pass gate pair 164, 166 to select or de-select the cell 132. At any time, multiple cells 132 in one bit in one column, i.e., between the same bit line pair 140, 142, may be in the same logic state, i.e., all storing all ones or all zeros. On the average, half of the cells 132 on such a bit line pair 140, 142 are hard off and have stabilized. After sufficient time with no access, i.e., with the word line 136 being held low, one pass gate 164 or 166 in each cell 132 is hard off and affected by body effects as described hereinabove. When a cell on the same bit line pair 140, 142 is being written, one side is pulled low and the hard off side of connected cells including the remaining unselected cells, would normally source transient bipolar current, i.e., exhibit body charge effects and slowing cell access. By contrast, body effect charge has been neutralized for the preferred RAM 130, at least in part and, access is unimpeded by body effects.

Figure 3C is an example of a timing diagram of neutralization timing for a RAM, such as RAM 130 of Figure 3A. Essentially, during a neutralization cycle, the column select logic 146 sequentially selects array columns 138 through corresponding pass gate pairs 148-0, 148-1, 148-2, 148-3 for neutralization through discharge pairs 152-0, 152-1, 152-2, 152-3, thereby discharging hard off pass gates in cells 130 and limiting switching current in such a discharge. So, as in the example of Figure 2C, each of the body charge monitor 110', pulse generator 112 and column select logic 146 are clocked by a common clock (not shown), e.g., that may be generated locally. Whenever the data path is idled for a sufficient period of time for body effect charge to have built up in pass gates 164, 166, body charge monitor circuit 110' will provide an indication to that effect. In response, the pulse generator 112 will generate a pulse 170, which passes to column

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select logic 146. Thereafter, each of the N columns are selected by an appropriate pulse 172-1, 172-2, 172-3, 172-4, ..., 172-n to a corresponding column 138. Coincidentally with the first pulse, the neutralization control signal 150 switches on discharge pairs 152-0, 152-1, 152-2 and, 152-3, which provide paths to ground for both bit lines 140, 142 of each pair. The neutralization pulse 174 width is a single cycle long and monitoring and neutralization are interrupted by a normal access. Again, subsequently, when a normal RAM access occurs, the access proceeds normally, unaffected by body effects.

Figure 4 shows a flow diagram 180 for monitoring and reducing body effect charging according to a preferred embodiment of the present invention. First, monitoring begins in step 182 after each access for a RAM or circuit activity for logic, when the monitor circuit beings/restarts monitoring circuit activity. In step 184 when enough time has passed the monitoring circuit provides an indication of body effect charging. In response in step 186, the pulse generator provides a neutralization pulse. In step 188, columns are sequentially selected for neutralization or the pulse is passed to logic blocks in the circuit path. In step 190, body effect charge is neutralized in selected columns/blocks. If additional columns/block remain unselected in step 192, then returning to step 188, the next column/block is selected. Otherwise, once all columns/logic blocks have been selected and neutralized in step 192 or at any time the array is accessed or circuit activity occurs, monitoring begins again in step 182.

Advantageously, body effect charge is neutrralized in sensitive circuits, reducing sporadic chip failures or soft errors.

While the invention has been described in terms of preferred embodiments, those skilled in the art will recognize that the invention can be practiced with modification within the spirit and scope of the appended claims.

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1	6. An IC as in claim 1, wherein said circuit path is a random access memory and	
2	said blocks are memory cells in a memory array.	
1	7. An IC as in claim 6, wherein said neutralization pulse distribution circuit is a	
2	column decode, selecting columns for discharge.	
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1	8. An IC as in claim 7, said IC further comprising:	
2	a column select selecting bit lines in said array; and	
3	a column discharge circuit, discharging bit lines selected by said column selec	t.
1	O An IC on in plain 8 wherein said had affect we with a second state of the second sta	
1	9. An IC as in claim 8, wherein said body effect monitor provides a neutralization	
2	control signal to said column discharge circuit, said column discharge circuit discharg	ing
3	selected said bit lines responsive to said neutralization control signal.	
1	10. An integrated circuit (IC) comprising:	
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2	at least one circuit path sensitive to floating body effects, said circuit path	
3	including a plurality of logic blocks;	
4	a body effect monitor, monitoring circuit activity for said at least one circuit pa	ath
5	and, selectively providing an indication of said floating body effects responsive to	
. 6	monitored circuit inactivity;	
7	a pulse generator generating a neutralization pulse responsive to said indication	n of
8	body effect charging;	
9	a test circuit, selectively providing test data for testing said logic blocks;	
10	a multiplexor selectively passing data from said test circuit and neutralization	
11	pulses from said pulse generator; and	
12	a neutralization pulse distribution circuit receiving selected said test data and s	aid
13	neutralization pulses and passing received said test data and said neutralization pulses	to
14	said logic blocks in said circuit path.	